AMENDMENTS TO THE CLAIMS:

This listing of claims will replace all prior versions and listings of claims in the application:

LISTING OF CLAIMS:

1. (Original) A micro-fabricated chip, comprising:

a stationary structure; and

a movable structure having a gimbal structure, the gimbal structure allowing pitch and roll motion of the movable structure with respect to the stationary structure.

2. (Original) The micro-fabricated chip according to claim 1, wherein the gimbal structure includes a dimple surface making a rolling-type contact with the stationary structure.

- 3. (Cancelled)
- 4. (Cancelled)
- 5. (Cancelled)
- 6. (Cancelled)

- 7. (Original) The micro-fabricated chip according to claim 1, wherein the micro-fabricated chip is a passive chip structure.
- 8. (Original) The micro-fabricated chip according to claim 1, wherein the micro-fabricated chip is a microactuator.
- 9. (Original) The micro-fabricated chip according to claim 8, wherein the movable structure moves in a rotational direction with respect to the stationary structure.
- 10. (Original) The micro-fabricated chip according to claim 8, wherein the movable structure moves in a translational direction with respect to the stationary structure.
 - 11. (Original) A suspension for a disk drive, comprising: a load beam;

a micro-fabricated chip having a stationary structure and a movable structure having a gimbal structure, the stationary structure being attached to the load beam and the gimbal structure allowing pitch and roll motion of the movable structure with respect to the stationary structure; and

a slider attached to the movable structure.

- 12. (Original) The suspension according to the claim 11, wherein the gimbal structure includes a dimple surface making a rolling-type contact with the stationary structure.
 - 13. (Cancelled)
 - 14. (Cancelled)
 - 15. (Cancelled)
 - 16. (Cancelled)
- 17. (Original) The suspension according to claim 11, wherein the micro-fabricated chip is a passive chip structure.
- 18. (Original) The suspension of claim 11, wherein the micro-fabricated chip is a microactuator.
- 19. (Original) The suspension of claim 18, wherein the movable structure and the slider move in a rotational direction with respect to the stationary structure.

20. (Original) The suspension according to claim 18, wherein the movable structure moves in a translational direction with respect to the stationary structure.

- 21. (Original) The suspension according to claim 11, further comprising a flexible cable that is directly attached to the load beam without mechanical compliance and forms at least one electrical connection to the micro-fabricated chip.
 - 22. (Original) A disk drive, comprising:

a suspension having a load beam;

a micro-fabricated chip having a stationary structure and a movable structure having a gimbal structure, the stationary structure being attached to the load beam and the gimbal structure allowing pitch and roll motion of the movable structure with respect to the stationary structure; and

a slider attached to the movable structure.

- 23. (Original) The disk drive according to claim 22, wherein the gimbal structure includes a dimple surface making a rolling-type contact with the stationary structure.
 - 24. (Cancelled)
 - 25. (Cancelled)

- 26. (Cancelled)
- 27. (Cancelled)
- 28. (Original) The disk drive according to claim 22, wherein the micro-fabricated chip is a passive chip structure.
- 29. (Original) The disk drive according to claim 22, wherein the micro-fabricated chip is a microactuator.
- 30. (Original) The disk drive according to claim 29, wherein the movable structure and the slider move in a rotational direction with respect to the stationary structure.
- 31. (Original) The disk drive according to claim 29, wherein the movable structure moves in a translational direction with respect to the stationary structure.
- 32. (Original) The disk drive according to claim 22, further comprising a flexible cable that is directly attached to the load beam without mechanical compliance and forms at least one electrical connection to the micro-fabricated chip.